TC1040

Linear Building Block – Dual Low Power Comparator and Voltage Reference with Shutdown

Features

- Combines Two Comparators and a Voltage Reference in a Single Package
- Optimized for Single Supply Operation
- Small Package: 8-Pin MSOP
- Ultra Low Input Bias Current: Less than 100pA
- Low Quiescent Current, Operating: 10µA (Typ.) Shutdown Mode: 6µA (Typ.)
- Rail-to-Rail Inputs and Outputs
- Operates Down to V_{DD} = 1.8V
- Reference and One Comparator Remain Active in Shutdown to Provide Supervisory Functions

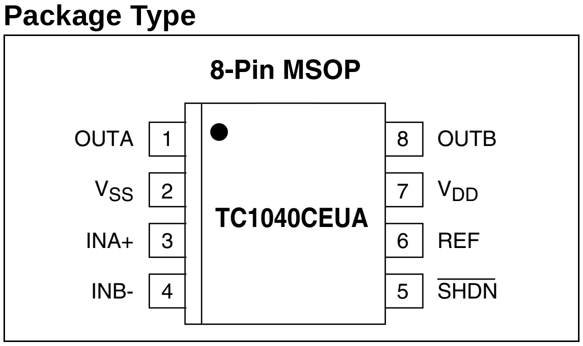
Applications

- Power Supply Circuits
- Battery Operated Equipment
- Consumer Products
- Replacements for Discrete Components

Device Selection Table

Part Number	Package	Temperature Range
TC1040CEUA	8-Pin MSOP	-40°C to +85°C

Package Type



General Description

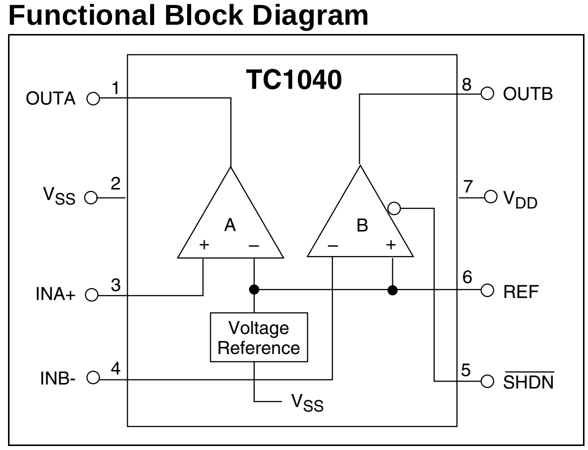
The TC1040 is a mixed-function device combining two comparators and a voltage reference in a single 8-pin package. The inverting input of Comparator A and the non-inverting input of Comparator B are internally connected to the reference.

This increased integration allows the user to replace two packages, which saves space, lowers supply current and increases system performance. The TC1040 operates from two 1.5V alkaline cells down to V_{DD} = 1.8V. It requires only 10µA typical of supply current, which significantly extends battery life. A low power shutdown input ($\overline{SHDN}$) disables one of the comparators, placing its outputs in a high-impedance state. This mode saves battery power and allows comparator outputs to share common analog lines (multiplexing). Shutdown current is 6µA (typical).

Rail-to-rail inputs and outputs allow operation from low supply voltages with large input and output signal swings.

Packaged in an 8-Pin MSOP, the TC1040 is ideal for applications requiring low power level detection.

Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS*

Supply Voltage 6.0V
Voltage on Any Pin ....(V_{SS} – 0.3V) to (V_{DD} + 0.3V)
Junction Temperature......................................+150°C
Operating Temperature Range.............-40°C to +85°C
Storage Temperature Range ....-55°C to +150°C

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

TC1040 ELECTRICAL SPECIFICATIONS

Electrical Characteristics: Typical values apply at 25°C and V_{DD} = 3.0V. Minimum and maximum values apply for T_A = -40° to +85°C and V_{DD} = 1.8V to 5.5V, unless otherwise specified.

Symbol	Parameter	Min	Typ	Max	Units	Test Conditions
V_{DD}	Supply Voltage	1.8	—	5.5	V	
I_Q	Supply Current Operating	—	10	15	µA	All outputs unloaded, $\overline{SHDN}$ = V_{DD}
I_{SHDN}	Supply Current, Shutdown	—	0.05	0.1	µA	$\overline{SHDN}$ = V_{SS}
Shutdown Input						
V_{IH}	Input High Threshold	80% V_{DD}	—	—	V	
V_{IL}	Input Low Threshold	—	—	20% V_{DD}	V	
I_{SI}	Shutdown Input Current	—	—	±100	nA	
Comparators						
R_{OUT}(SD)	Output Resistance in Shutdown	20	—	—	MΩ	$\overline{SHDN}$ = V_{SS}, COMPB only
C_{OUT}(SD)	Output Capacitance in Shutdown	—	—	5	pF	$\overline{SHDN}$ = V_{SS}, COMPB only
T_{SEL}	Select Time (For Valid Output)	—	20	—	µsec	($\overline{SHDN}$ = V_{IH} to V_{OUT}) R_L =10kΩ to $V_{SS,}$ COMPB only
T_{DESEL}	Deselect Time	—	500	—	nsec	($\overline{SHDN}$ = V_{IL} to V_{OUT}) R_L =10kΩ to $V_{SS,}$ COMPB only
V_{IR}	Input Voltage Range	V_{SS} – 0.2	—	V_{DD} + 0.2	V	
V_{OS}	Input Offset Voltage	-5 -5	—	+5 +5	mV	V_{DD} = 3V, T_A = 25°C T_A = -40°C to 85°C
I_B	Input Bias Current	—	—	±100	pA	T_A = 25°C, INA+, INB- = V_{DD} to V_{SS}
V_{OH}	Output High Voltage	V_{DD} – 0.3	—	—	V	R_L = 10kΩ to V_{SS}
V_{OL}	Output Low Voltage	—	—	0.3	V	R_L = 10kΩ to V_{DD}
PSRR	Power Supply Rejection Ratio	60	—	—	dB	T_A = 25°C V_{DD} = 1.8V to 5V
I_{SRC}	Output Source Current	1	—	—	mA	INA+ = V_{DD}, INB- = V_{SS} Output Shorted to V_{SS} V_{DD} = 1.8V
I_{SINK}	Output Sink Current	2	—	—	mA	INA+ = V_{SS}, INB- =$V_{DD,}$ Output Shorted to V_{DD} V_{DD} = 1.8V
t_{PD1}	Response Time	—	4	—	µsec	100mV Overdrive, C_L = 100pF
t_{PD2}	Response Time	—	6	—	µsec	10mV Overdrive, C_L = 100pF
Voltage Reference						
V_{REF}	Reference Voltage	1.176	1.200	1.224	V	
$I_{REF(SOURCE)}$	Source Current	50	—	—	µA	
$I_{REF(SINK)}$	Sink Current	50	—	—	µA	
$C_{L(REF)}$	Load Capacitance	—	—	100	pF	
E_{VREF}	Voltage Noise	—	20	—	μV_{RMS}	100Hz to 100kHz
e_{VREF}	Noise Density	—	1.0	—	$\mu V/\sqrt{Hz}$	1kHz

2.0 PIN DESCRIPTION

The description of the pins are listed in Table 2-1.

TABLE 2-1: PIN FUNCTION TABLE

Pin No. (8-Pin MSOP)	Symbol	Description
1	OUTA	Comparator output.
2	V_{SS}	Negative power supply.
3	INA+	Non-inverting input to Comparator A.
4	INB-	Inverting input to Comparator B.
5	$\overline{SHDN}$	Shutdown input.
6	REF	Voltage reference output.
7	V_{DD}	Positive power supply.
8	OUTB	Comparator output.

3.0 DETAILED DESCRIPTION

The TC1040 is one of a series of very low power, linear building block products targeted at low voltage, single supply applications. The TC1040 minimum operating voltage is 1.8V and typical supply current is only 10µA (fully enabled). It combines two comparators and a voltage reference in a single package. A shutdown mode is incorporated for easy adaptation to system power management schemes. During shutdown, one comparator is disabled (i.e., powered down with output at a high impedance). The “still awake” comparator and voltage reference can be used as a wake-up timer, power supply monitor, LDO controller or other continuous duty circuit function.

3.1 Comparators

The TC1040 contains two comparators. The comparator’s input range extends beyond both supply voltages by 200mV and the outputs will swing to within several millivolts of the supplies, depending on the load current being driven. The inverting input of Comparator A and the non-inverting input of Comparator B are internally connected to the output of the voltage reference.

The comparators exhibit a propagation delay and supply current which are largely independent of supply voltage. The low input bias current and offset voltage make them suitable for high impedance precision applications.

Comparator B is disabled during shutdown and has a high impedance output. Comparator COMPA remains active.

3.2 Voltage Reference

A 2.0 percent tolerance, internally biased, 1.20V bandgap voltage reference is included in the TC1040. It has a push-pull output capable of sourcing and sinking 50µA. The voltage reference remains fully enabled during shutdown.

3.3 Shutdown Input

$\overline{SHDN}$ at V_{IL} disables one comparator. The $\overline{SHDN}$ input cannot be allowed to float; when not used, connect it to V_{DD}. The disabled comparator’s output is in a high impedance state when shutdown is active. The disabled comparator’s inputs and outputs can be driven from rail-to-rail by an external voltage when the TC1040 is in shutdown. No latchup will occur when the device is driven to its enabled state when $\overline{SHDN}$ is set to V_{IH}.

4.0 TYPICAL APPLICATIONS

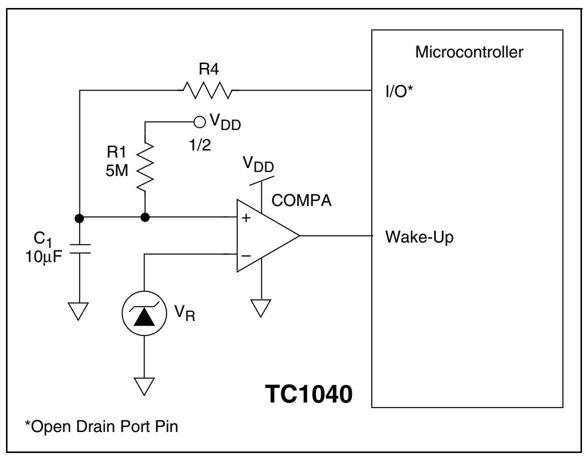
The TC1040 lends itself to a wide variety of applications, particularly in battery powered systems. It typically finds application in power management, processor supervisory and interface circuitry.

4.1 Wake-Up Timer

Many microcontrollers have a low-power “sleep” mode that significantly reduces their supply current. Typically, the microcontroller is placed in this mode via a software instruction, and returns to a fully-enabled state upon reception of an external signal (“wake-up”). The wake-up signal is usually supplied by a hardware timer. Most system applications demand that this timer have a long duration (typically seconds or minutes), and consume as little supply current as possible.

The circuit shown in Figure 4-1 is a wake-up timer made from Comparator A. (Comparator A is used because the wake-up timer must operate when $\overline{SHDN}$ is active.) Capacitor C1 charges through R1 until a voltage equal to V_R is reached, at which point the “wake-up” is driven active. Upon wake-up, the microcontroller resets the timer by forcing a logic low on a dedicated, open drain I/O port pin. This discharges C1 through R4 (the value of R4 is chosen to limit maximum current sunk by the I/O port pin). With a 3V supply, the circuit as shown consumes typically 8µA and furnishes a nominal timer duration of 25 seconds.

FIGURE 4-1: WAKE-UP TIMER



4.2 Precision Battery Monitor

Figure 4-2 is a precision battery low/battery dead monitoring circuit. Typically, the battery low output warns the user that a battery dead condition is imminent. Battery dead typically initiates a forced shutdown to prevent operation at low internal supply voltages (which can cause unstable system operation).

The circuit in Figure 4-2 uses a single TC1040, one-half of a TC1029, and only six external resistors. COMPA and COMPB provide precision voltage detection using V_R as a reference. Resistors R2 and R4 set the detection threshold for BATT LOW, while Resistors R1 and R7 set the detection threshold for BATT FAIL. The component values shown assert BATT LOW at 2.2V (typical) and BATT FAIL at 2.0 (typical). Total current consumed by this circuit is typically 22µA at 3V. Resistors R5 and R6 provide hysteresis for comparators COMPA and COMPB, respectively.

4.3 External Hysteresis (Comparator)

Hysteresis can be set externally with two resistors using positive feedback techniques (see Figure 4-3). The design procedure for setting external comparator hysteresis is as follows:

1. Choose the feedback resistor R_C. Since the input bias current of the comparator is at most 100pA, the current through R_C can be set to 100nA (i.e., 1000 times the input bias current) and retain excellent accuracy. The current through R_C at the comparator's trip point is V_R / R_C where V_R is a stable reference voltage.
2. Determine the hysteresis voltage (V_{HY}) between the upper and lower thresholds.
3. Calculate R_A as follows:

EQUATION 4-1:

$$R_A = R_C\left(\frac{V_{HY}}{V_{DD}}\right)$$

4. Choose the rising threshold voltage for V_{SRC} (V_{THR}).
5. Calculate R_B as follows:

EQUATION 4-2:

$$R_B = \frac{1}{\left[\left(\frac{V_{THR}}{V_R \times R_A}\right) - \frac{1}{R_A} - \frac{1}{R_C}\right]}$$

6. Verify the threshold voltages with these formulas:

   V_{SRC} rising:

EQUATION 4-3:

$$V_{THR} = (V_R)(R_A)\left[\left(\frac{1}{R_A}\right) + \left(\frac{1}{R_B}\right) + \left(\frac{1}{R_C}\right)\right]$$

   V_{SRC} falling:

EQUATION 4-4:

$$V_{THF} = V_{THR} - \left[\left(\frac{R_A \times V_{DD}}{R_C}\right)\right]$$

FIGURE 4-2: PRECISION BATTERY MONITOR

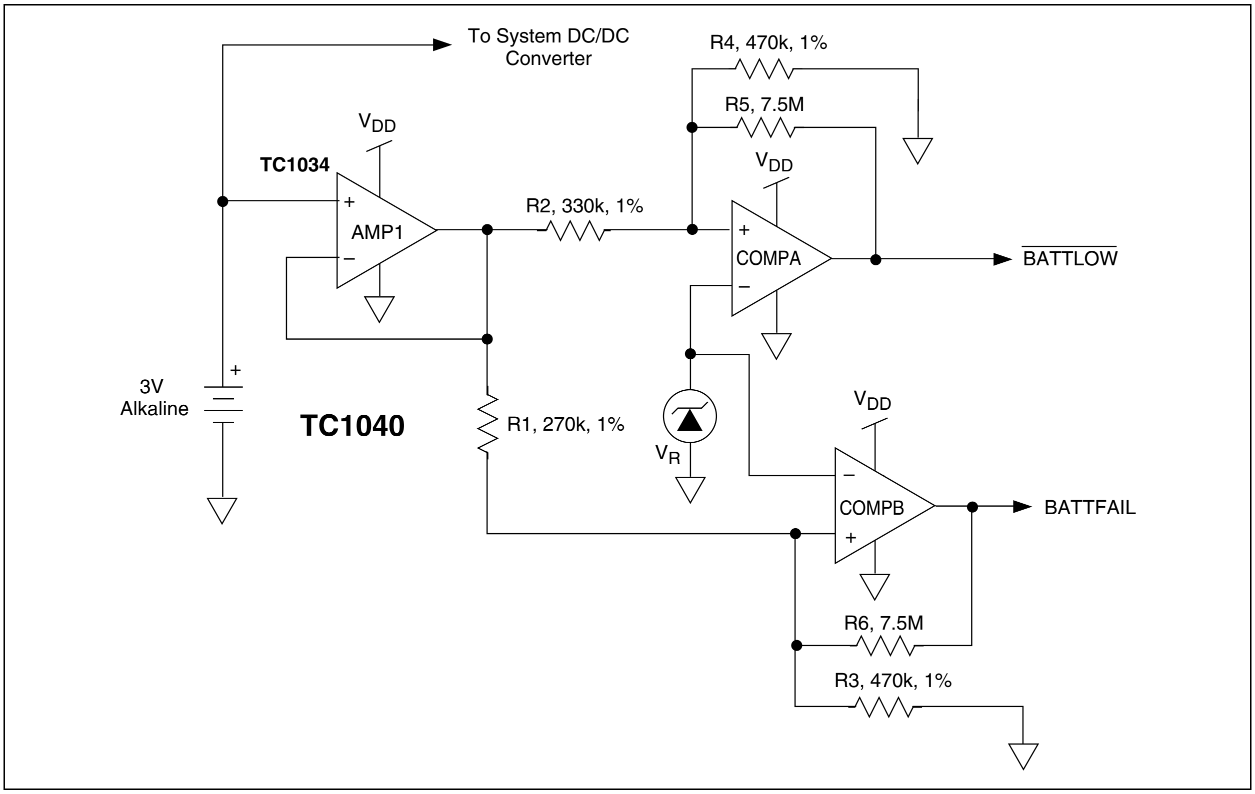
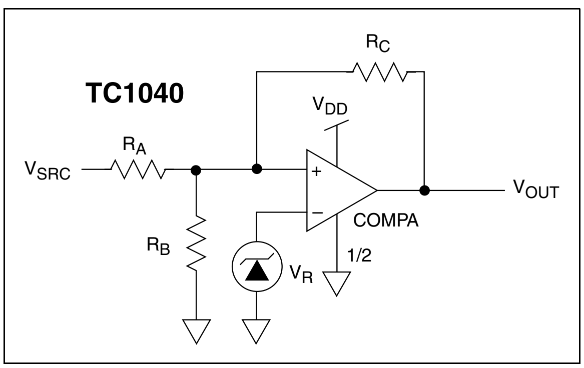


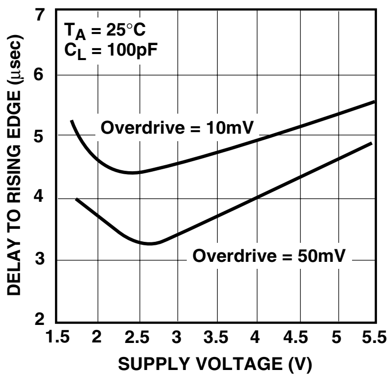
FIGURE 4-3: COMPARATOR EXTERNAL HYSTERESIS CONFIGURATION



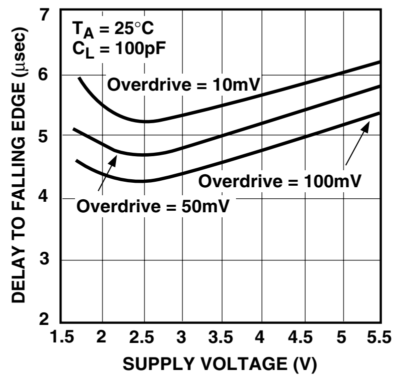
5.0 TYPICAL CHARACTERISTICS

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

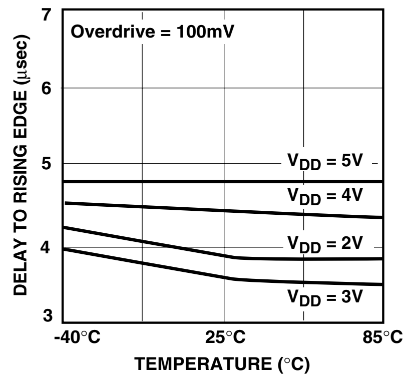
Comparator Propagation Delay vs. Supply Voltage



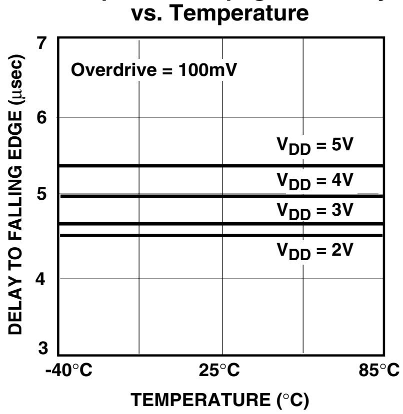
Comparator Propagation Delay vs. Supply Voltage



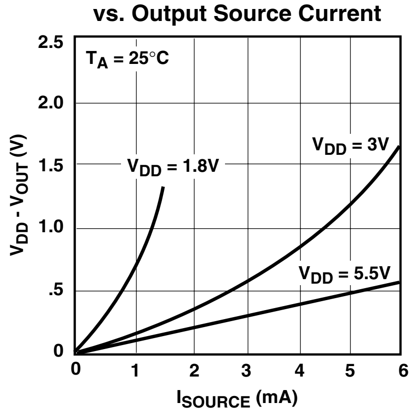
Comparator Propagation Delay vs. Temperature



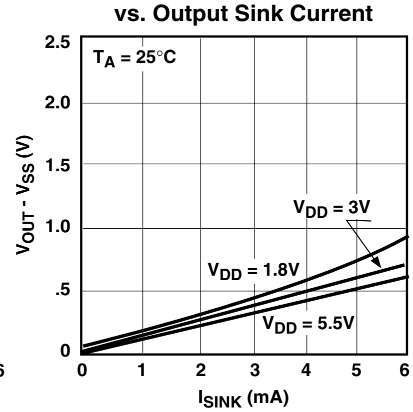
Comparator Propagation Delay vs. Temperature



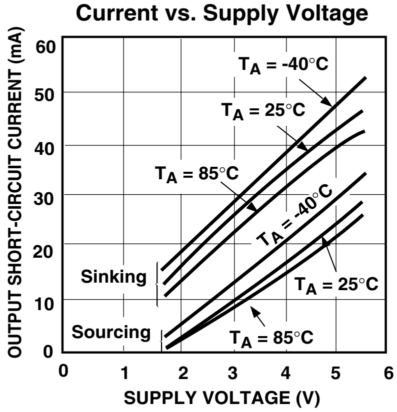
Comparator Output Swing vs. Output Source Current



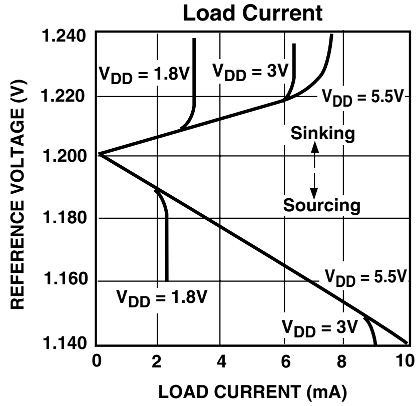
Comparator Output Swing vs. Output Sink Current



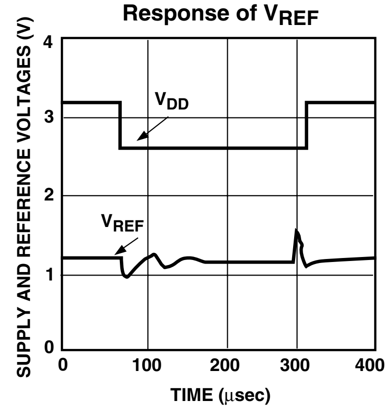
Comparator Output Short-Circuit Current vs. Supply Voltage



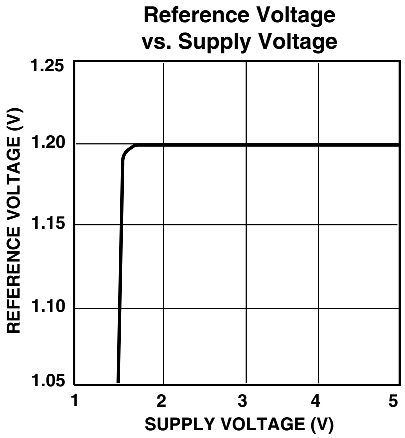
Reference Voltage vs. Load Current

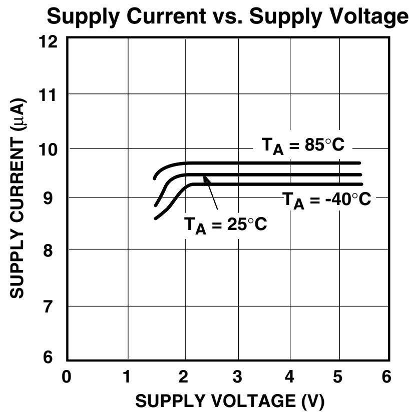


Line Transient Response of V_{REF}



5.0 TYPICAL CHARACTERISTICS (CONTINUED)





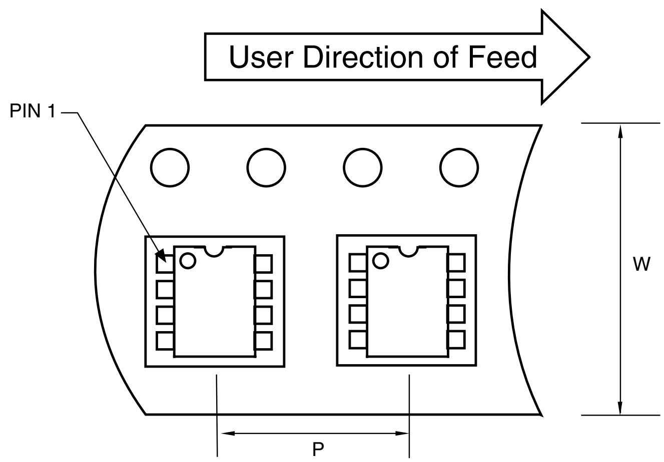
6.0 PACKAGING INFORMATION

6.1 Package Marking Information

Package marking data not available at this time.

6.2 Taping Form

Component Taping Orientation for 8-Pin MSOP Devices



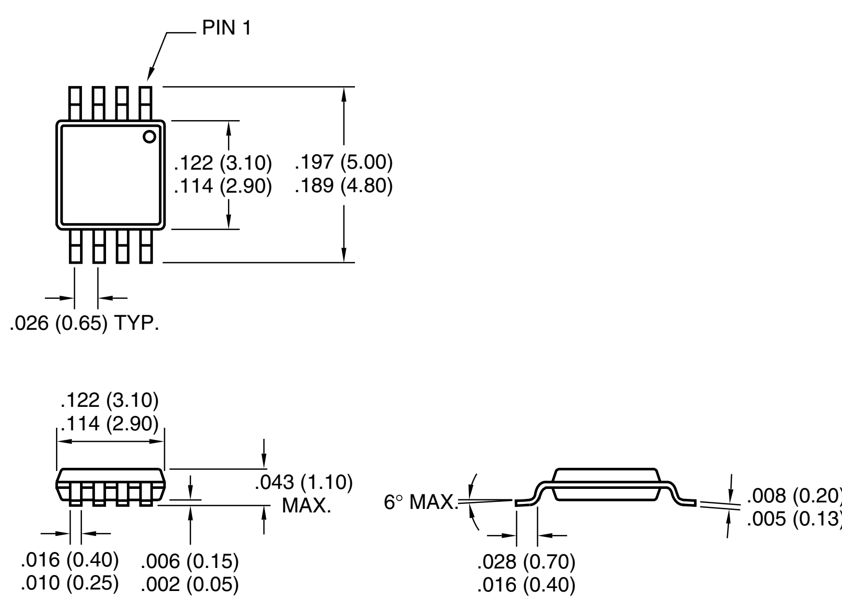
Standard Reel Component Orientation
for TR Suffix Device

Carrier Tape, Number of Components Per Reel and Reel Size

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
8-Pin MSOP	12 mm	8 mm	2500	13 in

6.3 Package Dimensions

8-Pin MSOP



Dimensions: inches (mm)

NOTES:

Sales and Support

Data Sheets
Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

1. Your local Microchip sales office
2. The Microchip Corporate Literature Center U.S. FAX: (480) 792-7277
3. The Microchip Worldwide Site (www.microchip.com)

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

New Customer Notification System
Register on our web site (www.microchip.com/cn) to receive the most current information on our products.

NOTES:

WORLDWIDE SALES AND SERVICE

AMERICAS

Corporate Office
2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7200 Fax: 480-792-7277
Technical Support: 480-792-7627
Web Address: http://www.microchip.com

Rocky Mountain
2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7966 Fax: 480-792-7456

Atlanta
500 Sugar Mill Road, Suite 200B
Atlanta, GA 30350
Tel: 770-640-0034 Fax: 770-640-0307

Boston
2 Lan Drive, Suite 120
Westford, MA 01886
Tel: 978-692-3848 Fax: 978-692-3821

Chicago
333 Pierce Road, Suite 180
Itasca, IL 60143
Tel: 630-285-0071 Fax: 630-285-0075

Dallas
4570 Westgrove Drive, Suite 160
Addison, TX 75001
Tel: 972-818-7423 Fax: 972-818-2924

Detroit
Tri-Atria Office Building
32255 Northwestern Highway, Suite 190
Farmington Hills, MI 48334
Tel: 248-538-2250 Fax: 248-538-2260

Kokomo
2767 S. Albright Road
Kokomo, Indiana 46902
Tel: 765-864-8360 Fax: 765-864-8387

Los Angeles
18201 Von Karman, Suite 1090
Irvine, CA 92612
Tel: 949-263-1888 Fax: 949-263-1338

New York
150 Motor Parkway, Suite 202
Hauppauge, NY 11788
Tel: 631-273-5305 Fax: 631-273-5335

San Jose
Microchip Technology Inc.
2107 North First Street, Suite 590
San Jose, CA 95131
Tel: 408-436-7950 Fax: 408-436-7955

Toronto
6285 Northam Drive, Suite 108
Mississauga, Ontario L4V 1X5, Canada
Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Australia
Microchip Technology Australia Pty Ltd
Suite 22, 41 Rawson Street
Epping 2121, NSW
Australia
Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing
Microchip Technology Consulting (Shanghai) Co., Ltd., Beijing Liaison Office
Unit 915
Bei Hai Wan Tai Bldg.
No. 6 Chaoyangmen Beidajie
Beijing, 100027, No. China
Tel: 86-10-85282100 Fax: 86-10-85282104

China - Chengdu
Microchip Technology Consulting (Shanghai) Co., Ltd., Chengdu Liaison Office
Rm. 2401, 24th Floor,
Ming Xing Financial Tower
No. 88 TIDU Street
Chengdu 610016, China
Tel: 86-28-6766200 Fax: 86-28-6766599

China - Fuzhou
Microchip Technology Consulting (Shanghai) Co., Ltd., Fuzhou Liaison Office
Unit 28F, World Trade Plaza
No. 71 Wusi Road
Fuzhou 350001, China
Tel: 86-591-7503506 Fax: 86-591-7503521

China - Shanghai
Microchip Technology Consulting (Shanghai) Co., Ltd.
Room 701, Bldg. B
Far East International Plaza
No. 317 Xian Xia Road
Shanghai, 200051
Tel: 86-21-6275-5700 Fax: 86-21-6275-5060

China - Shenzhen
Microchip Technology Consulting (Shanghai) Co., Ltd., Shenzhen Liaison Office
Rm. 1315, 13/F, Shenzhen Kerry Centre,
Renminnan Lu
Shenzhen 518001, China
Tel: 86-755-2350361 Fax: 86-755-2366086

Hong Kong
Microchip Technology Hongkong Ltd.
Unit 901-6, Tower 2, Metroplaza
223 Hing Fong Road
Kwai Fong, N.T., Hong Kong
Tel: 852-2401-1200 Fax: 852-2401-3431

India
Microchip Technology Inc.
India Liaison Office
Divyasree Chambers
1 Floor, Wing A (A3/A4)
No. 11, O'Shaugnessey Road
Bangalore, 560 025, India
Tel: 91-80-2290061 Fax: 91-80-2290062

Japan
Microchip Technology Japan K.K.
Benex S-1 6F
3-18-20, Shinyokohama
Kohoku-Ku, Yokohama-shi
Kanagawa, 222-0033, Japan
Tel: 81-45-471- 6166 Fax: 81-45-471-6122

Korea
Microchip Technology Korea
168-1, Youngbo Bldg. 3 Floor
Samsung-Dong, Kangnam-Ku
Seoul, Korea 135-882
Tel: 82-2-554-7200 Fax: 82-2-558-5934

Singapore
Microchip Technology Singapore Pte Ltd.
200 Middle Road
#07-02 Prime Centre
Singapore, 188980
Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan
Microchip Technology Taiwan
11F-3, No. 207
Tung Hua North Road
Taipei, 105, Taiwan
Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

EUROPE

Denmark
Microchip Technology Nordic ApS
Regus Business Centre
Lautrup hoj 1-3
Ballerup DK-2750 Denmark
Tel: 45 4420 9895 Fax: 45 4420 9910

France
Microchip Technology SARL
Parc d'Activite du Moulin de Massy
43 Rue du Saule Trapu
Batiment A - ler Etage
91300 Massy, France
Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany
Microchip Technology GmbH
Gustav-Heinemann Ring 125
D-81739 Munich, Germany
Tel: 49-89-627-144 0 Fax: 49-89-627-144-44

Italy
Microchip Technology SRL
Centro Direzionale Colleoni
Palazzo Taurus 1 V. Le Colleoni 1
20041 Agrate Brianza
Milan, Italy
Tel: 39-039-65791-1 Fax: 39-039-6899883

United Kingdom
Arizona Microchip Technology Ltd.
505 Eskdale Road
Winnersh Triangle
Wokingham
Berkshire, England RG41 5TU
Tel: 44 118 921 5869 Fax: 44-118 921-5820

03/01/02